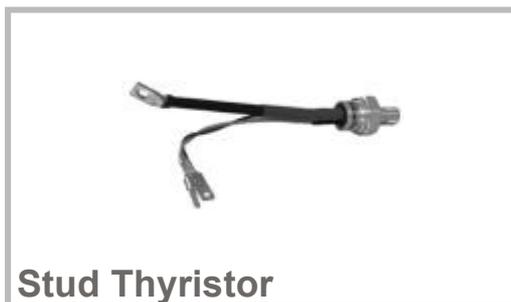


# SKT 55



$V_{RSM}$ V	$V_{RRM}, V_{DRM}$ V	$I_{TRMS} = 110$ A (maximum value for $I_{TAV} = 55$ A (sin. 180; T
500	400	SKT 55/04D
700	600	SKT 55/06D
900	800	SKT 55/08D
1300	1200	SKT 55/12E
1500	1400	SKT 55/14E
1700	1600	SKT 55/16E
1900	1800	SKT 55/18E

## Line Thyristor

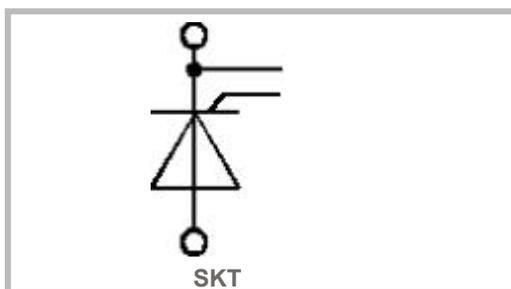
**SKT 55**

### Features

- Hermetic metal case with glass insulator
- Threaded stud ISO M12
- International standard case

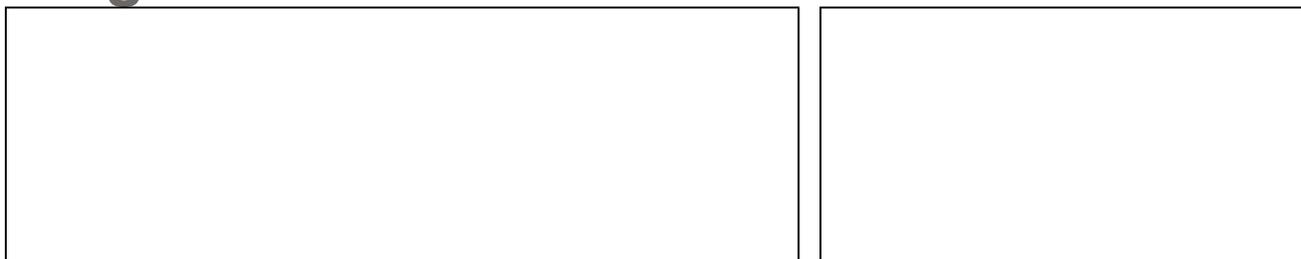
### Typical Applications

- DC motor control (e. g. for machines tools)
- Controlled rectifiers (e. g. for battery charging)
- AC controllers (e. g. for temperature control)
- Recommended snubber network e. g. for  $V_{VRMS} \leq 400$  V:  
 $R = 47 \Omega/10$  W,  $C = 0,22 \mu F$



Symbol	Conditions
$I_{TAV}$	sin. 180; $T_c = 100$ (85) °C;
$I_D$	K3; $T_a = 45$ °C; B2 / B6 K1,1; $T_a = 45$ °C; B2 / B6
$I_{RMS}$	K3; $T_a = 45$ °C; W1C
$I_{TSM}$	$T_{vj} = 25$ °C; 10 ms $T_{vj} = 130$ °C; 10 ms
$i^2t$	$T_{vj} = 25$ °C; 8,35 ... 10 ms $T_{vj} = 130$ °C; 8,35 ... 10 ms
$V_T$	$T_{vj} = 25$ °C; $I_T = 200$ A
$V_{T(TO)}$	$T_{vj} = 130$ °C
$r_T$	$T_{vj} = 130$ °C
$I_{DD}; I_{RD}$	$T_{vj} = 130$ °C; $V_{RD} = V_{RRM}; V_{DD} = V_{DRM}$
$t_{gd}$	$T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/ $\mu$ s
$t_{gr}$	$V_D = 0,67 * V_{DRM}$
$(di/dt)_{cr}$	$T_{vj} = 130$ °C
$(dv/dt)_{cr}$	$T_{vj} = 130$ °C ; SKT ...D / SKT ...E
$t_q$	$T_{vj} = 130$ °C ,
$I_H$	$T_{vj} = 25$ °C; typ. / max.
$I_L$	$T_{vj} = 25$ °C; typ. / max.
$V_{GT}$	$T_{vj} = 25$ °C; d.c.
$I_{GT}$	$T_{vj} = 25$ °C; d.c.
$V_{GD}$	$T_{vj} = 130$ °C; d.c.
$I_{GD}$	$T_{vj} = 130$ °C; d.c.
$R_{th(j-c)}$	cont.
$R_{th(j-c)}$	sin. 180
$R_{th(j-c)}$	rec. 120
$R_{th(c-s)}$	
$T_{vj}$	
$T_{stg}$	
$V_{isol}$	
$M_s$	to heatsink
a	
m	approx.
Case	

## Diagrams



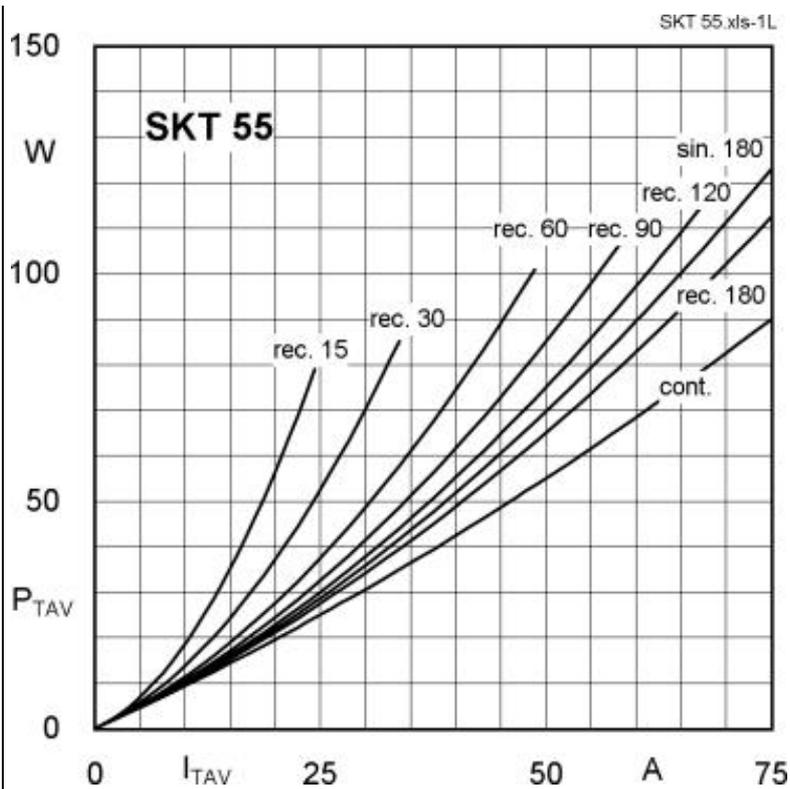


Fig. 1L Power dissipation vs. on-state current

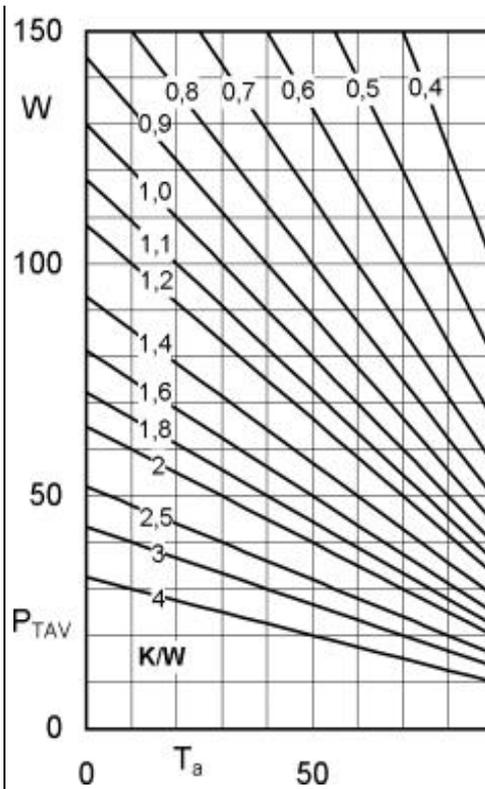


Fig. 1R Power dissipation vs. ambient temper

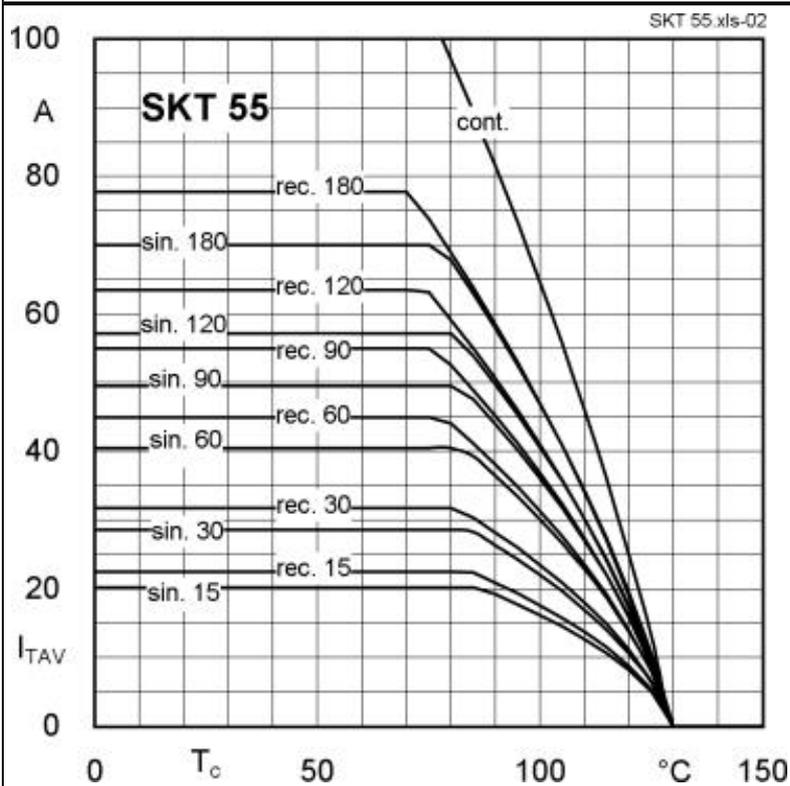


Fig. 2 Rated on-state current vs. case temperature

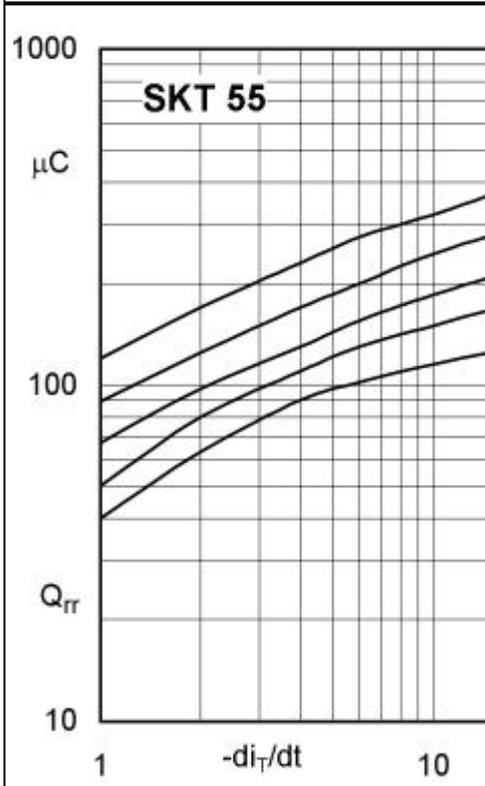


Fig. 3 Recovered charge vs. current decrease

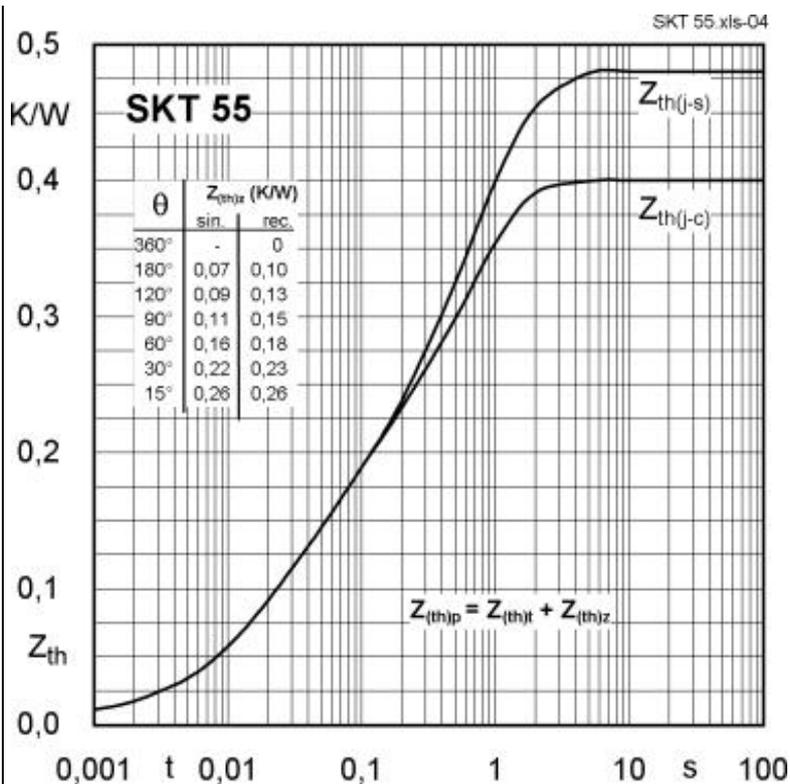


Fig. 4 Transient thermal impedance vs. time

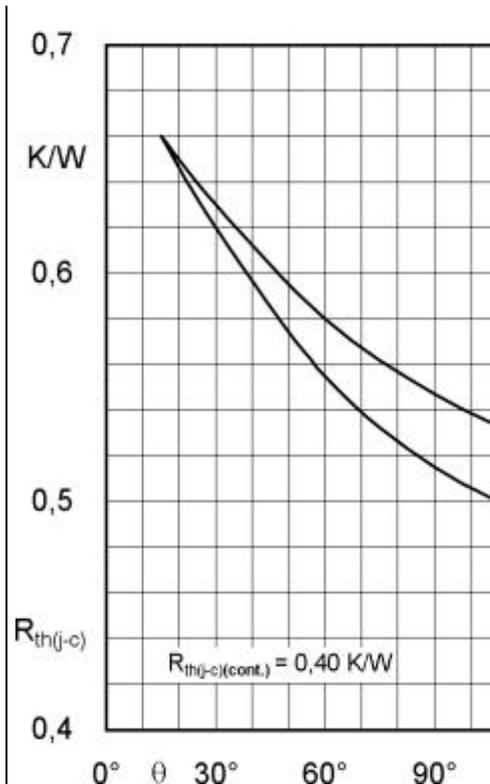


Fig. 5 Thermal resistance vs. conduction angle

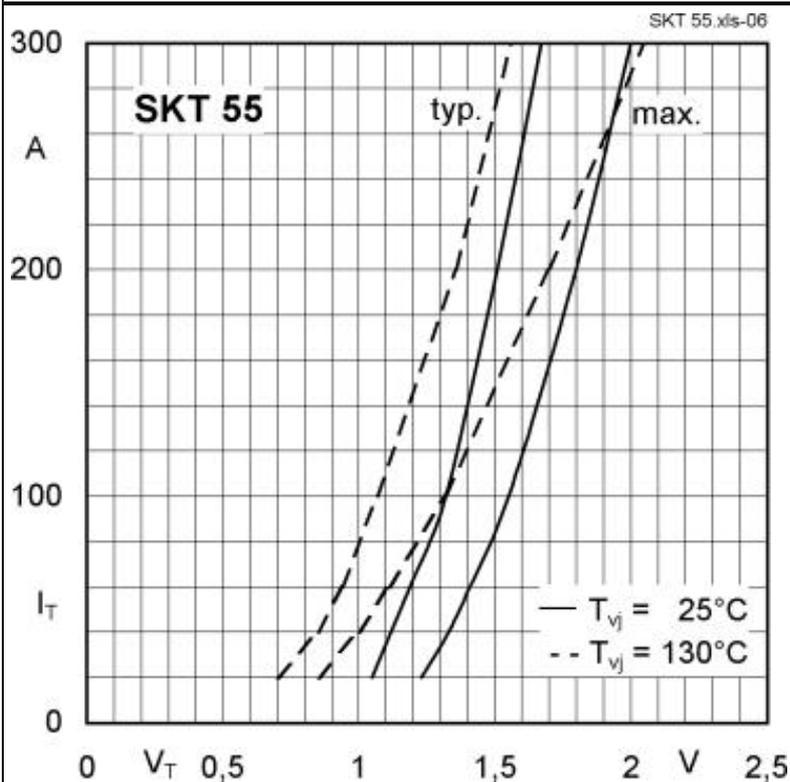


Fig. 6 On-state characteristics

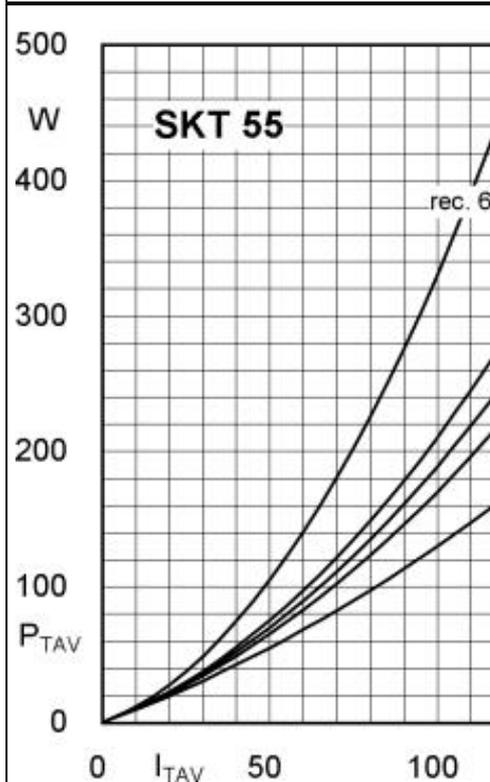
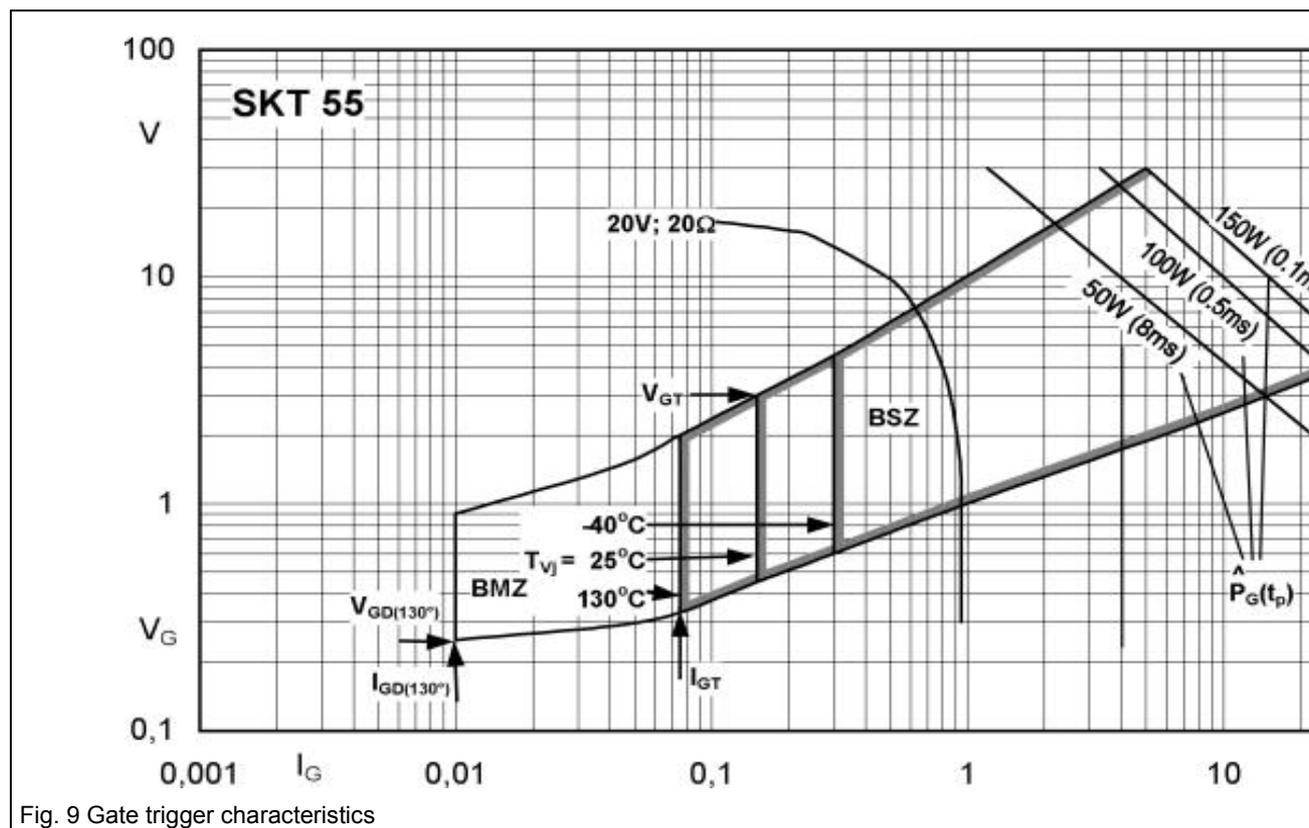
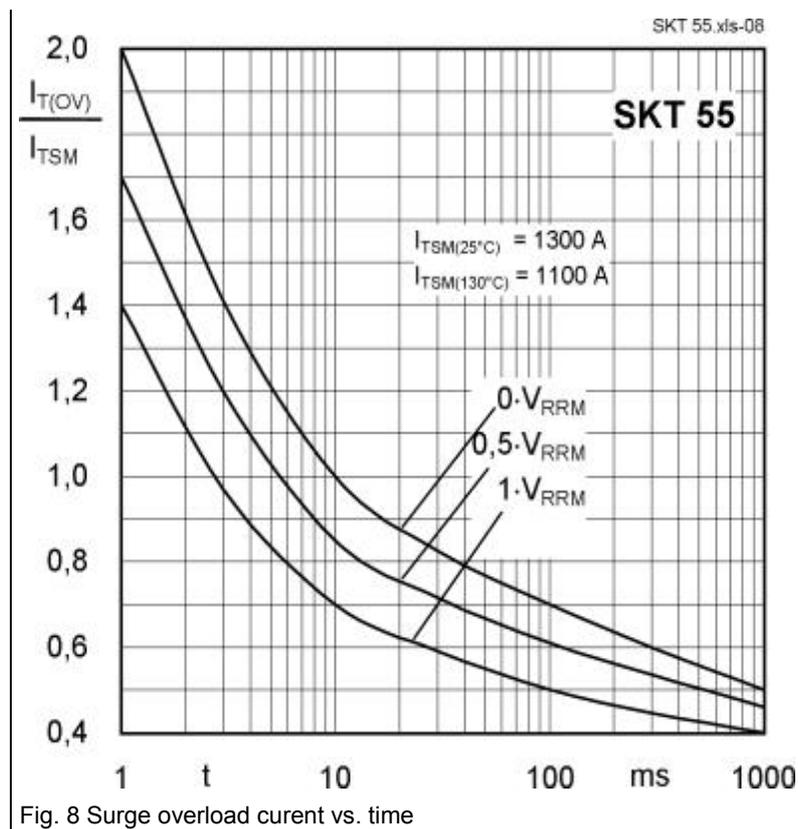
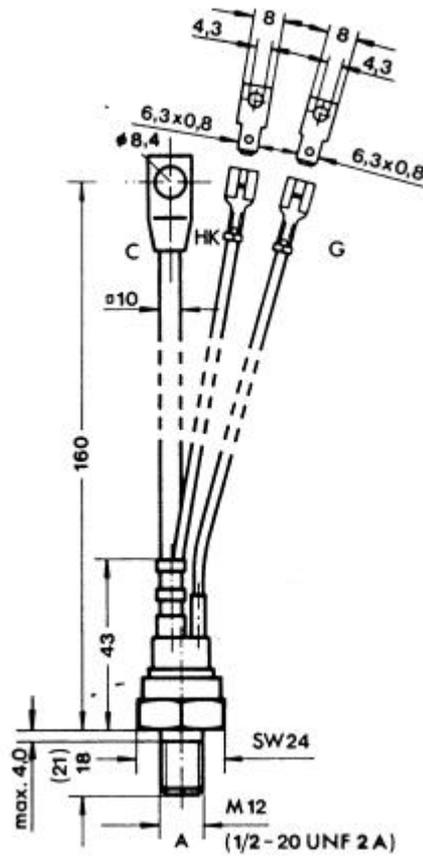


Fig. 7 Power dissipation vs. on-state current



## Cases / Circuits



**Case B 5 (IEC 60191-2: A12MA, A12U; JEDEC: TO209 (TO94))**

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